



09/649,8257

Hits	Search Text	DB	Time stamp
		<u> </u>	
-	thermoset\$5 with thermoplastic with tape		2003/06/25
		1	20:14
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- 25		·	2003/06/25
	tape) same double adj3 side\$3		20:25
		DERWENT;	İ
		IBM_TDB	
- 120	(thermoset\$5 with thermoplastic with	USPAT;	2003/06/25
	tape) and (chip or die or circuit).ab.	US-PGPUB;	20:26
		EPO; JPO;	i
		DERWENT;	
		IBM TDB	
- 50	(thermoset\$5 with thermoplastic with	USPAT;	2003/06/25
	tape) same (mix\$5 or blend)	US-PGPUB;	21:57
	<u> </u>	EPO; JPO;	
		DERWENT;	
		IBM TDB	
- 6237	thermoset\$5 with thermoplastic with	USPĀT;	2003/06/25
		US-PGPUB;	21:59
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			•
		IBM TDB	i
480	(thermoset\$5 with thermoplastic with	_	2003/06/25
		1	22:00
	'		
- 98	((thermoset\$5 with thermoplastic with		2003/06/26
			18:25
		1 '	
	orreare or beinteendactor, case, and tape		
		_	
	442 25 120 50 6237	thermoset\$5 with thermoplastic with tape  (thermoset\$5 with thermoplastic with tape) same double adj3 side\$3  (thermoset\$5 with thermoplastic with tape) and (chip or die or circuit).ab.  (thermoset\$5 with thermoplastic with tape) same (mix\$5 or blend)  thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)  (thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)  (thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)) and (chip or die or circuit or semiconductor).ab.	thermoset\$5 with thermoplastic with tape  25 (thermoset\$5 with thermoplastic with tape) same double adj3 side\$3  120 (thermoset\$5 with thermoplastic with tape) and (chip or die or circuit).ab.  (thermoset\$5 with thermoplastic with tape) and (chip or die or circuit).ab.  (thermoset\$5 with thermoplastic with tape) same (mix\$5 or blend)  (thermoset\$5 with thermoplastic with tape) same (mix\$5 or blend)  480 (thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)  (thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)) and (chip or die or circuit or semiconductor).ab.  (thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)) and (chip or die or circuit or semiconductor).ab.  (thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)) and (chip or die or circuit or semiconductor).ab.  (thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)) and (chip or die or US-PGPUB;